

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(semiconductor and device and assembly and plurality and comprising and die and having and active and surface and least and one and bond and pad and thereon and opposing and surface and projection and secured and configured and flip and chip and connection and including and solder and ball and bump and metal and paddle and frame and narrow and common and electrical and leads and pair and rails and cross).clm.	US-PGPUB	OR	ON	2007/01/20 19:19